Substitute Disclosure Form (PTO-1449)

Substitute Form PTO-1449		U.S. Department of Commerce Patent and Trademark Office		Attorney's Docket No. 10417-101001		Application No.		PTO
Formati n Disclosure Statement by Applicant			Applicant Haruo Hyodo et al.				Ø	
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Initial /	Foreig Desig. ID AL AM AN AN AO AP	Document Number Hei10-173117	Publication Date 06.26.1998	Country or Patent Office Japan	Class H01L	Subclass 23/50	Yes	N
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Initial /	Foreig Desig. ID AL AM AN AN AO AP	Document Number Hei10-173117	Publication Date 06.26.1998	Country or Patent Office  Japan  , Title, Date, and	Class H01L	Subclass 23/50	Yes	N
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Initial /	Foreig Desig. ID AL AM AN AO AP Other D Desig. ID AQ	Document Number Hei10-173117	Publication Date 06.26.1998	Country or Patent Office  Japan  , Title, Date, and	Class H01L	Subclass 23/50 of Publicat	Yes Yes	N
Initial /	Foreig Desig. ID AL AM AN AO AP Other D Desig. ID AQ AR AS	Document Number Hei10-173117	Publication Date 06.26.1998	Country or Patent Office  Japan  , Title, Date, and	Class H01L	Subclass 23/50 of Publicat	Yes	N
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